

MMBD2004S

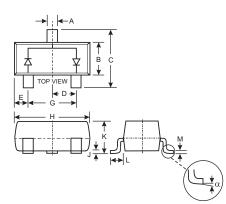
HIGH VOLTAGE SURFACE MOUNT SWITCHING DIODE

Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- High Reverse Breakdown Voltage
- Dual Series Configuration
- Lead Free/RoHS Compliant (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Ordering Information, See Sheet 2
- Marking: KA9 or KAE (See Page 2)
- Weight: 0.008 grams (approximate)



SOT-23									
Dim	Min	Max							
Α	0.37	0.51							
В	1.20	1.40							
С	2.30	2.50							
D	0.89	1.03							
E	0.45	0.60							
G	1.78	2.05							
Н	2.80	3.00							
J	0.013	0.10							
K	0.903	1.10							
L	0.45	0.61							
М	0.085	0.180							
α	0°	8°							
All Dimensions in mm									

Maximum Ratings @ TA = 25°C unless otherwise specified

Characteristic	5	Symbol	Value	Unit	
Repetitive Peak Reverse Voltage		V_{RRM}	300	V	
Working Peak Reverse Voltage DC Blocking Voltage		$V_{RWM} \ V_{R}$	240	V	
RMS Reverse Voltage	\	V _{R(RMS)}	170	V	
Forward Continuous Current (Note 2)		I _{FM}	225	mA	
Peak Repetitive Forward Current (Note 2)		I _{FRM}	625	mA	
	@ t = 1.0μs @ t = 1.0s	I _{FSM}	4.0 1.0	А	
Power Dissipation (Note 2)		P_d	350	mW	
Thermal Resistance Junction to Ambient Air (N	lote 2)	R _θ JA	357	°C/W	
Operating and Storage Temperature Range	Т	Γ _j , T _{STG}	-65 to +150	°C	

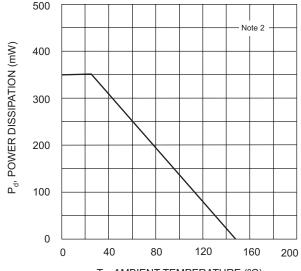
Electrical Characteristics @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	300	_	V	$I_R = 100 \mu A$
Forward Voltage	V _F	_	0.87 1.0	V	I _F = 20mA I _F = 100mA
Reverse Current (Note 1)	I _R	_	100	nA μA	V _R = 240V V _R = 240V, T _j = 150°C
Total Capacitance	Ст	_	5.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_	50	ns	$I_F = I_R = 30\text{mA},$ $I_{rr} = 3.0\text{mA}, R_L = 100\Omega$

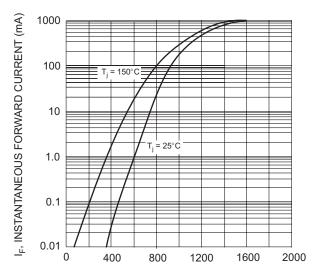
Notes:

- 1. Short duration test pulse used to minimize self-heating effect.
- Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 3. No purposefully added lead.

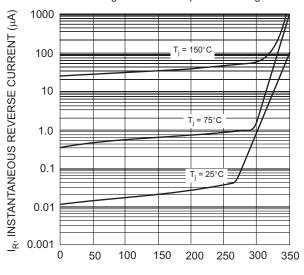




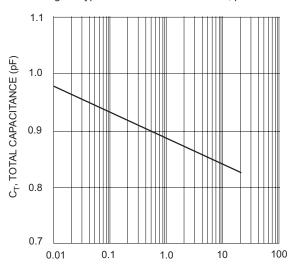
T_A, AMBIENT TEMPERATURE (°C) Fig. 1 Power Dissipation Derating



V_F, INSTANTANEOUS FORWARD VOLTAGE (mV) Fig. 2 Typical Forward Characteristics, per element



V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 3 Typical Reverse Characteristics, per element



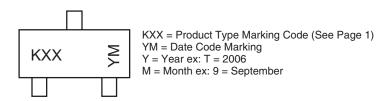
V_R, REVERSE VOLTAGE (V) Fig. 4 Typical Total Capacitance vs. Reverse Voltage, per element

Ordering Information (Note 4)

Device	Packaging	Shipping		
MMBD2004S-7-F	SOT-23	3000/Tape & Reel		

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	Ма	r Apr	Ma	y Ju	n Ju	I Aug	Sep	Oct	Nov	Dec



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